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(71) Applicant (for all designated States except US): AVANEX CORPORATION [US/US]; 40919 Encyclopedia Circle, Fremont, CA 94538 (US).

(72) Inventors; and

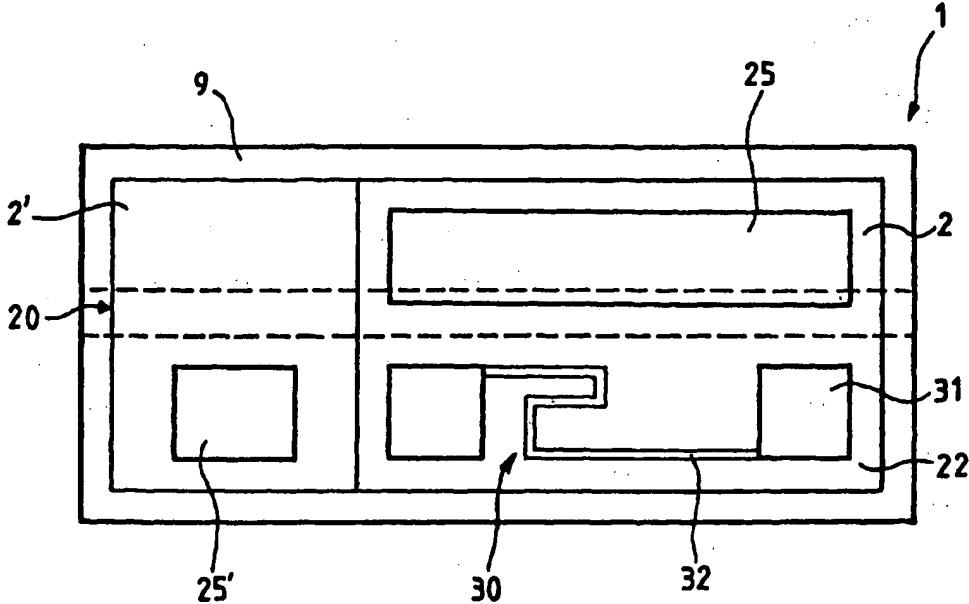
(75) Inventors/Applicants (for US only): DE LA GRANDIERE, Damien [FR/FR]; c/o Alcatel CIT, Route de Nozay, F-91460 Marcoussis (FR). BURIE, Jean-Rene [FR/FR]; 16, rue du Pre D'Arny, F-91680 Bruyeres Le Chatel (FR).

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(54) Title: INTEGRATED THERMAL SENSOR FOR OPTOELECTRONIC MODULES



(57) Abstract: An optoelectronic module comprising at least one optical component placed on a support, said component comprising an active optical layer and at least one confinement layer which carries at least one electrical contact, wherein said module further comprises a thermal sensor comprising a temperature-dependent resistive material which extends over the confinement layer of the optical component, at the side of the electrical contact of said component.

WO 2004/079399 A2



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